# 2SK0615 (2SK615)

### Silicon N-Channel MOS FET

For switching

#### Features

- Low ON-resistance
- High-speed switching

Parameter

Allowable power dissipation

Drain to Source voltage

Gate to Source voltage

Drain current

Max drain current

- Allowing to be driven directly by CMOS and TTL
- M type package, allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

Symbol

 $V_{DS}$ 

V<sub>GSO</sub>

 $I_{\rm D}$ 

I<sub>DP</sub>

 $P_D^*$ 

Ratings

80

20

±0.5

 $\pm 1$ 

1

Unit

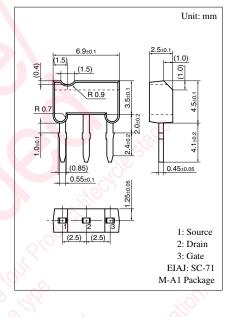
V

V

A

A

W



#### ■ Absolute Maximum Ratings (Ta = 25°C)

Channel temperature	T <sub>ch</sub>	150	°C				
Storage temperature	T <sub>stg</sub>	-55 to +150	°C				
* PC board: Copper foil of the drain portion should have a area of 1 cm <sup>2</sup> or							

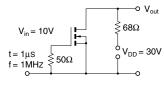
PC board: Copper foil of the drain portion should have a area of 1cm<sup>2</sup> o more and the board thickness should be 1.7mm.

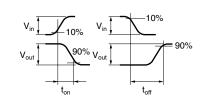
#### Electrical Characteristics (Ta = 25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	I <sub>DSS</sub>	$V_{\rm DS} = 60 V, V_{\rm GS} = 0$	S.	5	10	μΑ
Gate to Source leakage current	I <sub>GSS</sub>	$V_{GS} = 20V, V_{DS} = 0$	1. 2	Sec. 1	0.1	μΑ
Drain to Source breakdown voltage	V <sub>DSS</sub>	$I_{DS} = 100 \mu A, V_{GS} = 0$	80	SI.		V
Gate threshold voltage	V <sub>th</sub>	$I_D = 1 \text{mA}, V_{DS} = V_{GS}$	1.5	X.	3.5	V
Drain to Source ON-resistance	R <sub>DS(on)</sub> <sup>*1</sup>	$I_D = 0.5A, V_{GS} = 10V$		2	4	Ω
Forward transfer admittance	Y <sub>fs</sub>	$I_D = 0.2A, V_{DS} = 15V, f = 1kHz$	<u>S</u> ,	300		mS
Input capacitance (Common Source)	C <sub>iss</sub>	and the second second		45		pF
Output capacitance (Common Source)	C <sub>oss</sub>	$V_{DS} = 10V, V_{GS} = 0, f = 1MHz$		30		pF
Reverse transfer capacitance (Common Source)	C <sub>rss</sub>			8		pF
Turn-on time	t <sub>on</sub> *1, 2	Non Kin		15		ns
Turn-off time	t <sub>off</sub> *1, 2			20		ns

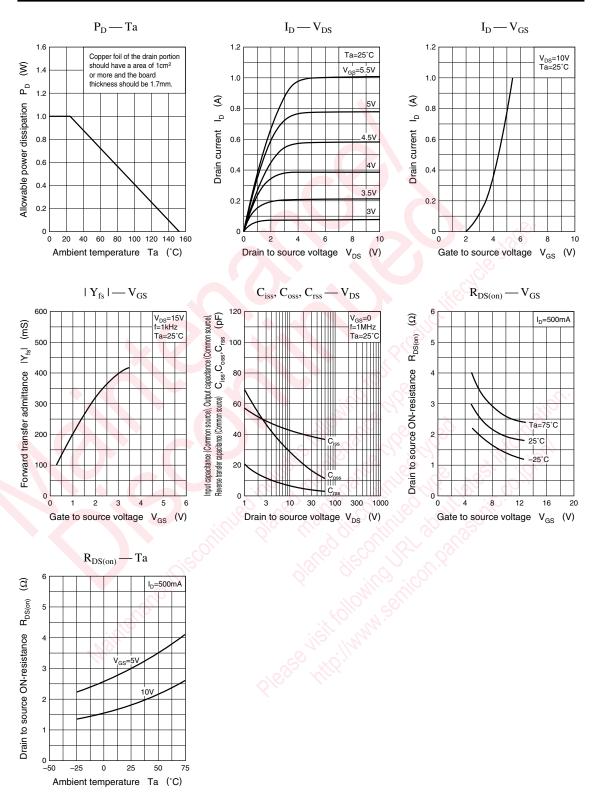
\*1 Pulse measurement

\*2 ton, toff measurement circuit





Note) The part number in the parenthesis shows conventional part number.



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